

SUBMINIATURE SOLID STATE LAMP

AM27YC08

YELLOW

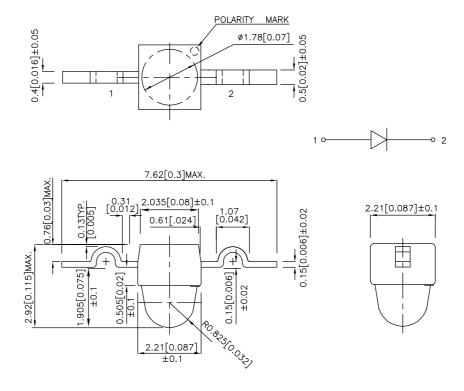
Features

- •SUBMINIATURE PACKAGE.
- •WIDE VIEWING ANGLE.
- •YOKE LEAD.
- •LONG LIFE-SOLID STATE RELIABILITY.
- •LOW PACKAGE PROFILE.
- •PACKAGE: 1000PCS/REEL.
- •RoHS COMPLIANT.

Description

The Yellow source color devices are made with Gallium Arsenide Phosphide on Gallium Phosphide Yellow Light Emitting Diode.

Package Dimensions



- 1. All dimensions are in millimeters (inches).
- 2. Tolerance is $\pm 0.25 (0.01")$ unless otherwise noted.
- 3. Lead spacing is measured where the lead emerge from the package.4. Specifications are subject to change without notice.

SPEC NO: DSAD1317 **REV NO: V.2** DATE: MAR/10/2005 **PAGE: 1 OF 4** APPROVED: J. Lu CHECKED: Allen Liu DRAWN: S.H.CHEN ERP:1202000438

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Selection Guide

Part No.	Dice	Lens Type	Iv (mcd) @ 20mA		Viewing Angle
			Min.	Тур.	2 01/2
AM27YC08	YELLOW (GaAsP/GaP)	WATER CLEAR	10	30	20°

Note

Electrical / Optical Characteristics at Ta=25°C

Symbol	Parameter	Device	Тур.	Max.	Units	Test Conditions
λpeak	Peak Wavelength	Yellow	590		nm	IF=20mA
λD	Dominant Wavelength	Yellow	588		nm	IF=20mA
Δλ1/2	Spectral Line Half-width	Yellow	35		nm	IF=20mA
С	Capacitance	Yellow	20		pF	VF=0V;f=1MHz
VF	Forward Voltage	Yellow	2.1	2.5	V	IF=20mA
IR	Reverse Current	Yellow		10	uA	VR = 5V

Absolute Maximum Ratings at TA=25°C

Parameter	Yellow	Units
Power dissipation	105	mW
DC Forward Current	30	mA
Peak Forward Current [1]	140	mA
Reverse Voltage	5	V
Operating/Storage Temperature	-40°C To +85°C	

Note:

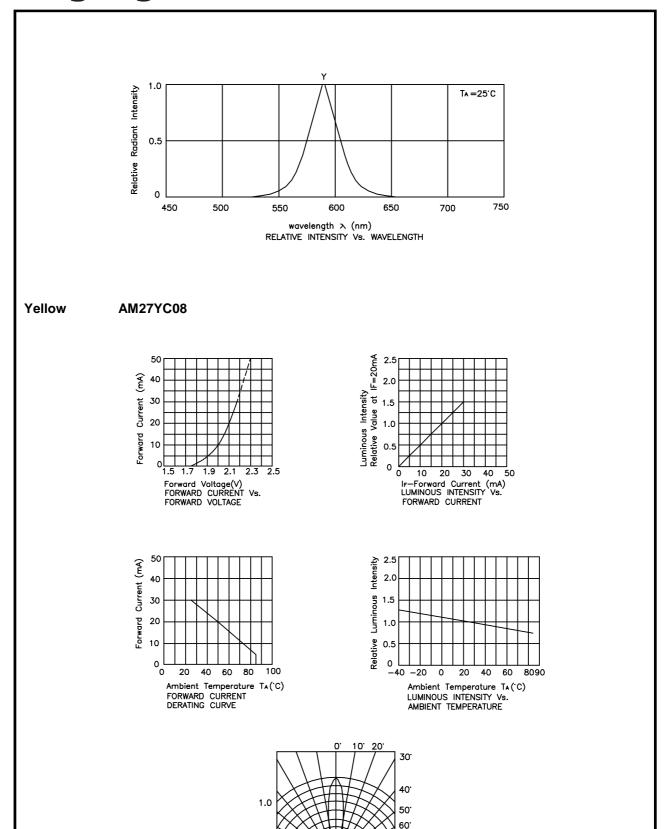
1. 1/10 Duty Cycle, 0.1ms Pulse Width.

 SPEC NO: DSAD1317
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 PAGE: 2 OF 4

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 $^{1. \, \}theta 1/2$ is the angle from optical centerline where the luminous intensity is 1/2 the optical centerline value.

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0.7

SPATIAL DISTRIBUTION

DATE: MAR/10/2005 DRAWN: S.H.CHEN

70°

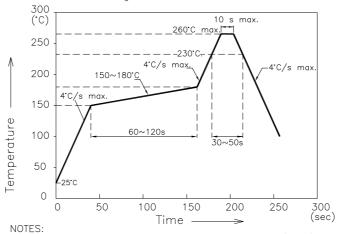
90

PAGE: 3 OF 4 ERP:1202000438

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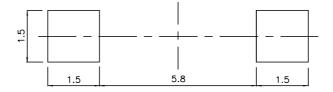
Reflow Soldering Profile For Lead-free SMT Process.



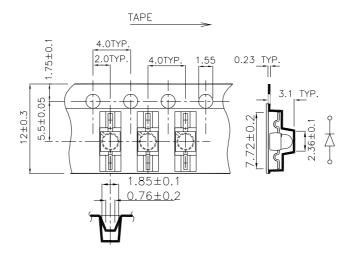
1.We recommend the reflow temperature 245°C(±5°C).The maximum soldering temperature should be limited to 260°C.
2.Don't cause stress to the epoxy resin while it is exposed to high temperature.

3. Number of reflow process shall be 2 times or less.

Recommended Soldering Pattern (Units: mm)



Tape Specifications (Units: mm)



Remarks:

If there is sorting requirement (eg. forward voltage, luminous intensity or wavelength), the condition as follows:

- 1. Wavelength: +/-1nm (Test condition is based on the sorting standard).
- 2.Luminous intensity: +/-15% (Test condition is based on the sorting standard).
- 3. Forward voltage: +/-0.1V (Test condition is based on the sorting standard).

 SPEC NO: DSAD1317
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 PAGE: 4 OF 4

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